

AN7560Z

BTL output power IC for car audio

■ Overview

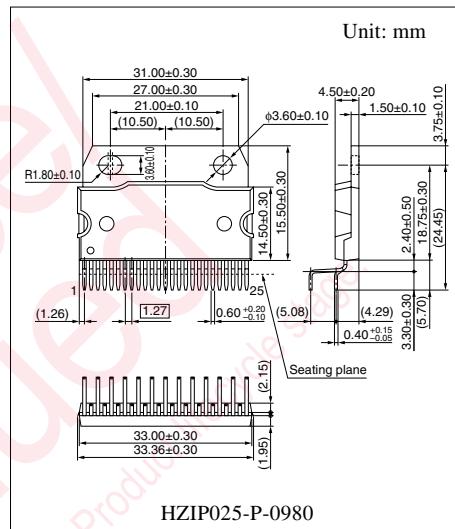
The AN7560Z is an audio power IC developed as the sound output of car audio (35 W by 4-ch.). A capacitor and resistor to stop oscillation are built in between the output pin and GND so that a space saving of set is possible. Also, it incorporates a perfect muting circuit without shock noise so that a shock noise design under the set transient condition can be made easily when used together with its standby function. In addition, it incorporates various protection circuits to protect the IC from destruction by GND-open-shortcircuit to ground and power supply surge which are the important subject of power IC protection. This IC will largely contribute to a high reliability design of the equipment.

■ Features

- A pattern layout in which input and output pattern do not intersect each other on single-sided printed circuit board is possible.
- Incorporating various protection circuits (temperature, shortcircuit to V_{CC} , V_{CC} -open short circuit to V_{CC} , shortcircuit to GND, GND-open short circuit to GND, overvoltage, power supply surge, and ASO, etc.)
- Built-in standby function (shock noise-free when STB-on/off)
- Built-in muting function (shock noise-free when Mute-on/off)
- External components reduction
- Provided with beep sound input pin
- Equipped with auxiliary sound input pin

■ Applications

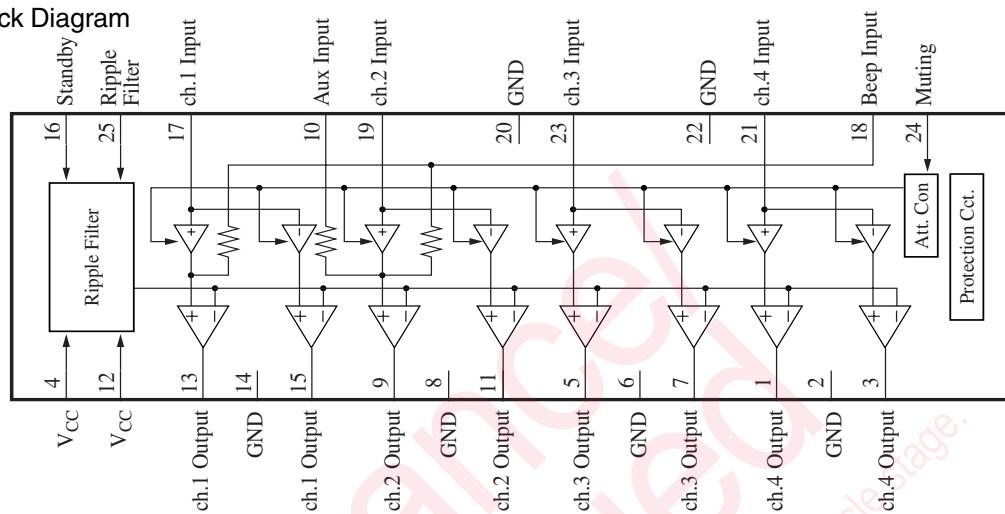
- Car stereo, miniature audio component, karaoke and other audio equipment.



HZIP025-P-0980

Note) The package of this product will be changed to lead-free type (HZIP025-P-0980B). See the new package dimensions section later of this datasheet.

■ Block Diagram



■ Pin Descriptions

Pin No.	Description	Pin No.	Description
1	ch.4 Output (+)	14	GND(Output ch.1)
2	GND (Output ch.4)	15	ch.1 Output (-)
3	ch.4 Output (-)	16	Standby
4	V _{CC}	17	ch.1 Input
5	ch.3 Output (+)	18	Beep Sound Input
6	GND(Output ch.3)	19	ch.2 Input
7	ch.3 Output (-)	20	GND (Input)
8	GND (Output ch.2)	21	ch.4 Input
9	ch.2 Output (+)	22	GND (Sub)
10	Auxiliary sound input	23	ch.3 Input
11	ch.2 Output (-)	24	Muting
12	V _{CC}	25	Ripple Filter
13	ch.1 Output (+)		

■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage * ²	V _{CC}	25	V
Peak supply voltage * ³	V _{surge}	65	V
Supply current	I _{CC}	12	A
Power dissipation * ⁴	P _D	59	W
Operating ambient temperature * ¹	T _{opr}	-30 to +85	°C
Storage temperature * ¹	T _{stg}	-55 to +150	°C

Note) *1 : All items are at T_a = 25°C, except for the operating ambient temperature and storage temperature.

*2 : Without signal

*3 : Time = 0.2 s.

*4 : Power dissipation at T_a = 85°C.

■ Recommended Operating Range

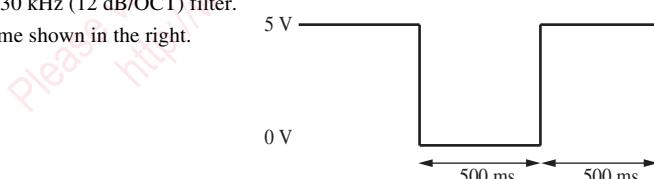
Parameter	Symbol	Range	Unit
Supply voltage	V _{CC}	8.0 to 18.0	V

■ Electrical Characteristics at V_{CC} = 13.2 V, f = 1 kHz, T_a = 25°C

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Quiescent current	I _{CQ}	R _g = 10 kΩ, R _L = 4 Ω	—	300	450	mA
Standby current	I _{STB}	R _g = 10 kΩ, R _L = 4 Ω	—	1	10	μA
Output noise voltage ^{*1}	V _{NO}	R _g = 10 kΩ, R _L = 4 Ω	—	0.15	0.5	mV[rms]
Voltage gain	G _V	V _{IN} = 40 mV[rms], R _L = 4 Ω	32	34	36	dB
Total harmonic distortion 1	THD1	V _{IN} = 40 mV[rms], R _L = 4 Ω	—	0.05	0.2	%
Maximum output power 1	P _{O1}	THD = 10%, R _L = 4 Ω	16	19.5	—	W
Ripple rejection ^{*1}	RR	R _g = 10 kΩ, R _L = 4 Ω V _R = 1 V[rms], f _R = 1 kHz	60	68	—	dB
Channel balance	CB	V _{IN} = 40 mV[rms], R _L = 4 Ω	—	0	1	dB
Cross-talk	CT	R _g = 10 kΩ, R _L = 4 Ω V _{IN} = 40 mV[rms]	60	70	—	dB
Output offset voltage	V _{OFF}	R _g = 10 kΩ, R _L = 4 Ω	-250	0	250	mV
Muting effect ^{*1}	MT	V _{IN} = 40 mV[rms], R _L = 4 Ω	70	86	—	dB
Input impedance	Z _I	V _{IN} = ± 0.3 V _{DC}	24	30	36	kΩ
Shock noise ^{*2}	V _S	R _g = 10 kΩ, R _L = 4 Ω, V _{MUTE} = 5 V V _{STB} = on/off, 50 Hz HPF	-100	0	100	mV[0-P]
Total harmonic distortion 2	THD2	V _{IN} = 20 mV[rms], f _{IN} = 20 kHz R _g = 10 kΩ, R _L = ∞	—	0.1	0.5	%
Mute On threshold voltage	MT _{ON}	V _{IN} = 40 mV[rms], R _L = 4 Ω	4	—	—	V
Mute Off threshold voltage	MT _{OFF}	V _{IN} = 40 mV[rms], R _L = 4 Ω	—	—	0.8	V
Maximum output power 2	P _{O2}	V _{IN} = 1 V[rms], R _L = 4 Ω	—	28	—	W
Maximum output power 3	P _{O3}	V _{CC} = 14.4 V, THD = 10%, R _L = 4 Ω	—	21	—	W
Maximum output power 4	P _{O4}	V _{CC} = 14.4 V, V _{IN} = 1 V[rms], R _L = 4 Ω	—	34	—	W

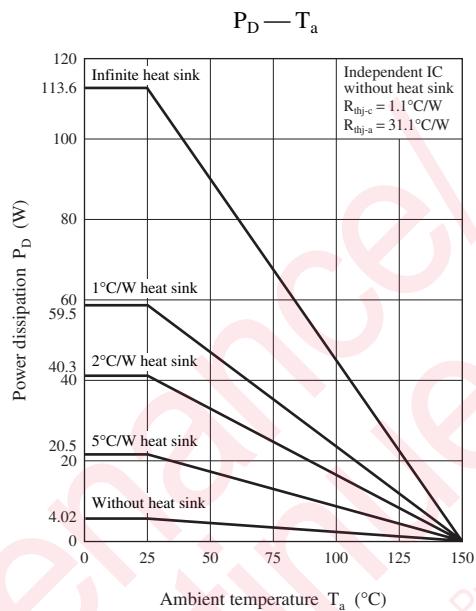
Note) *1 : Measurement using a bandwidth 15 Hz to 30 kHz (12 dB/OCT) filter.

*2 : Change over the standby terminal at the time shown in the right.

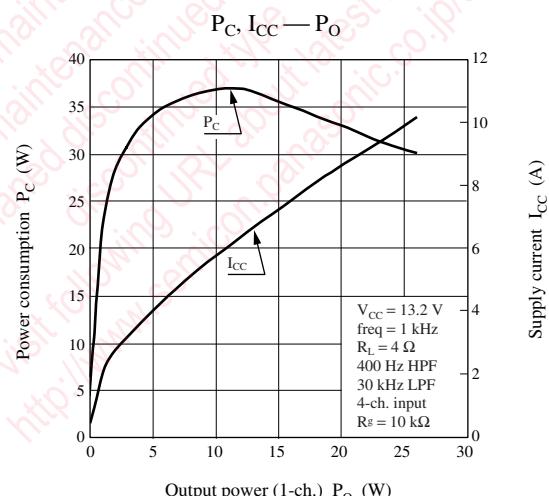
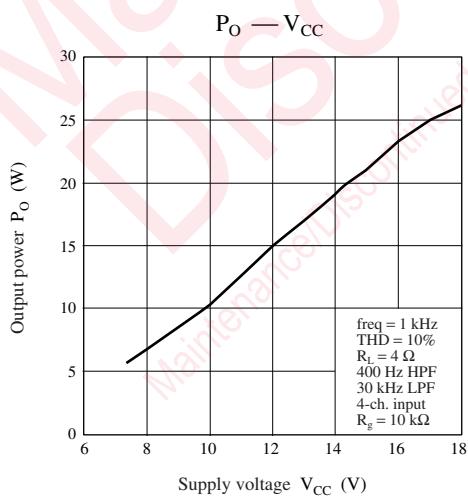


■ Technical Information

1. P_D — T_a curves of HZIP025-P-0980



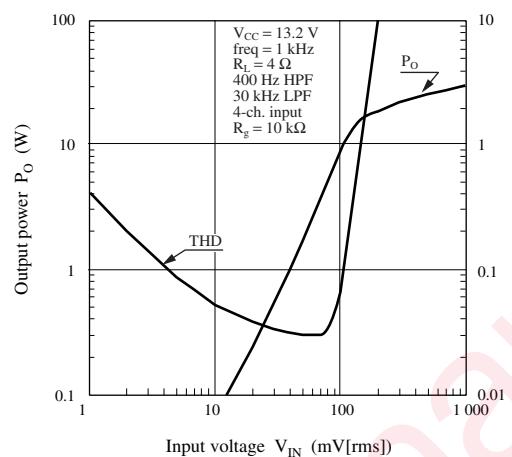
2. Main characteristics



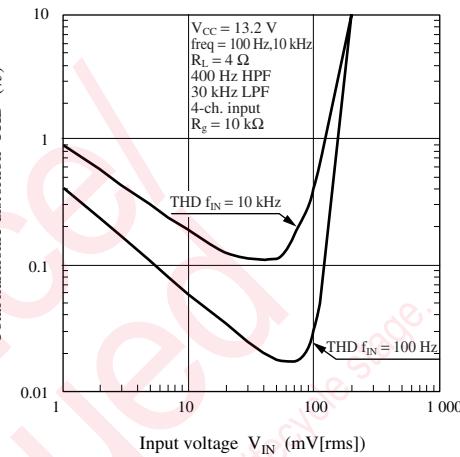
■ Technical Information (continued)

2. Main characteristics (continued)

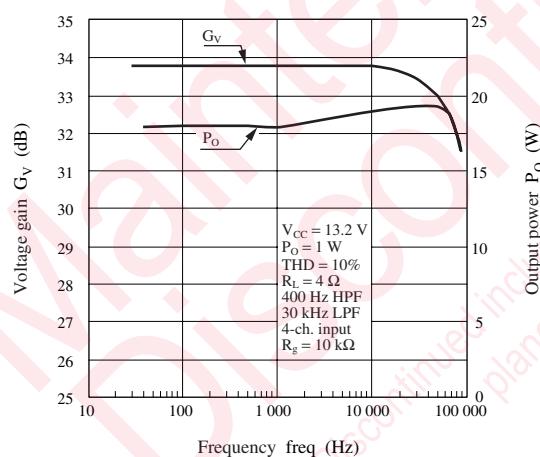
P_O , THD — V_{IN}



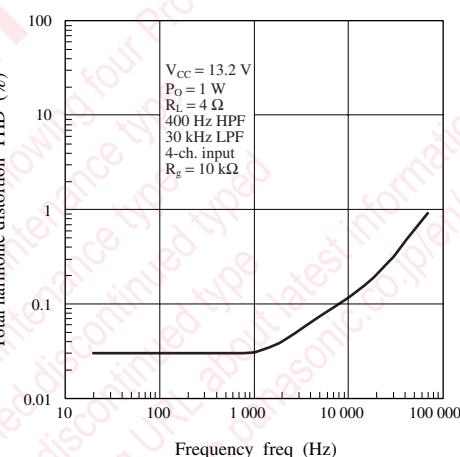
THD — V_{IN}



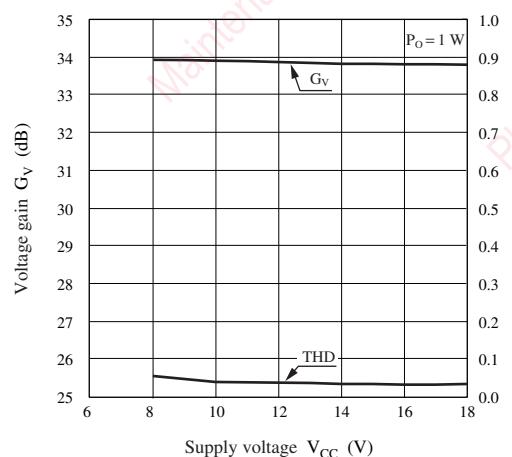
G_V , P_O — freq



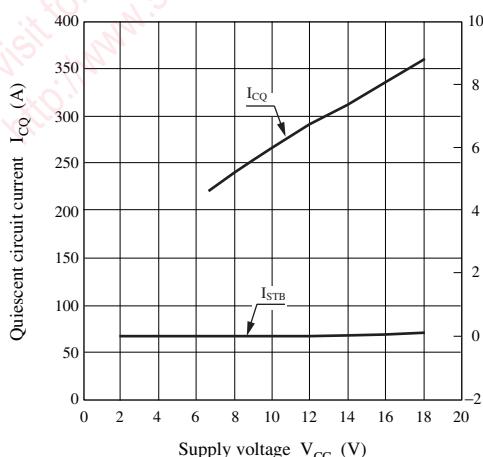
THD — freq



G_V , THD — V_{CC}

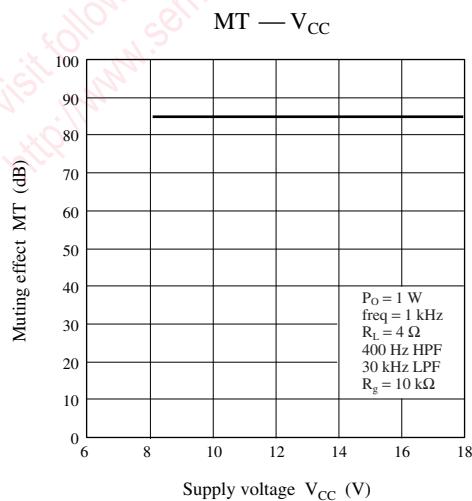
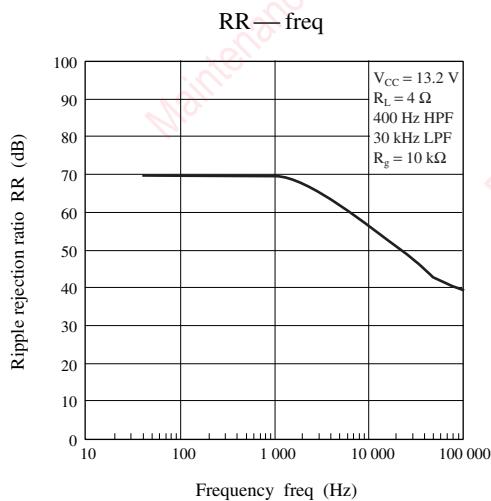
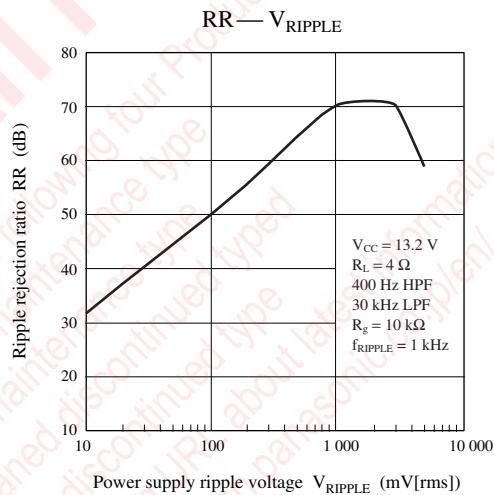
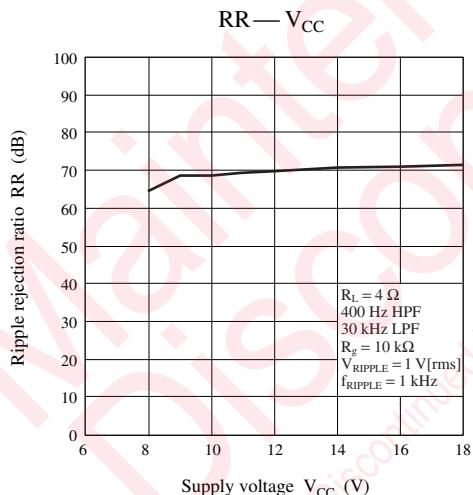
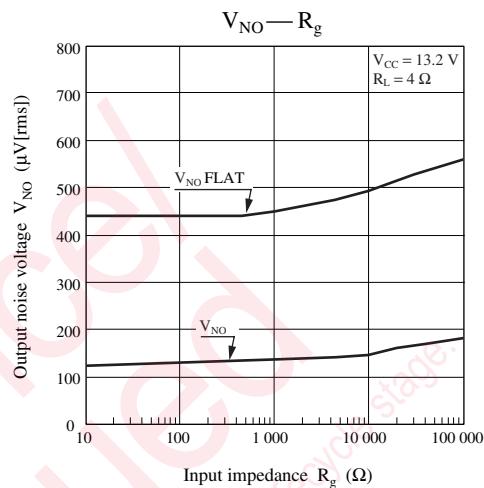
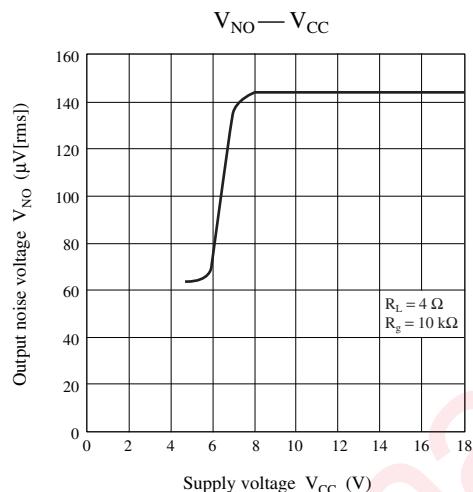


I_{CQ} , I_{STB} — V_{CC}



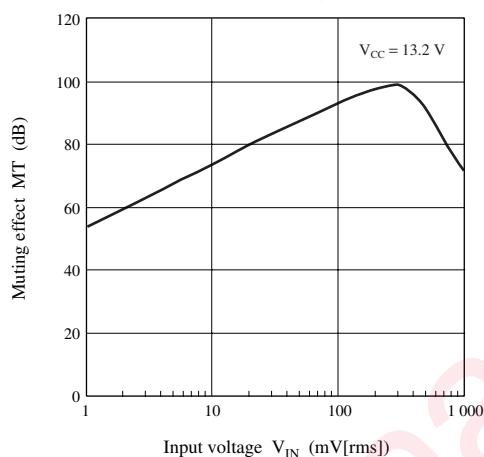
■ Technical Information (continued)

2. Main characteristics (continued)

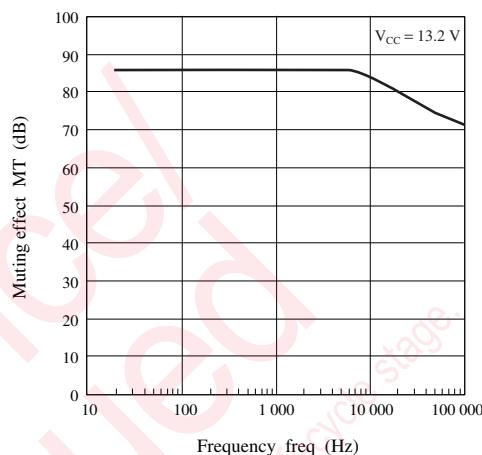
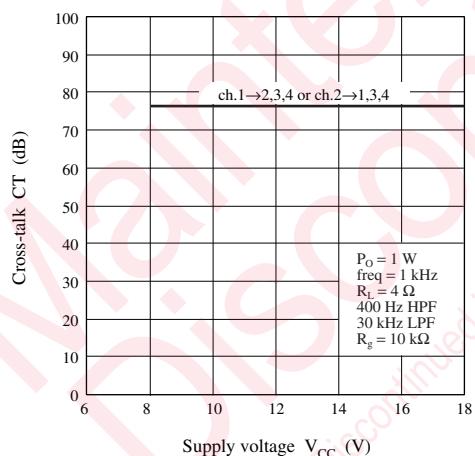
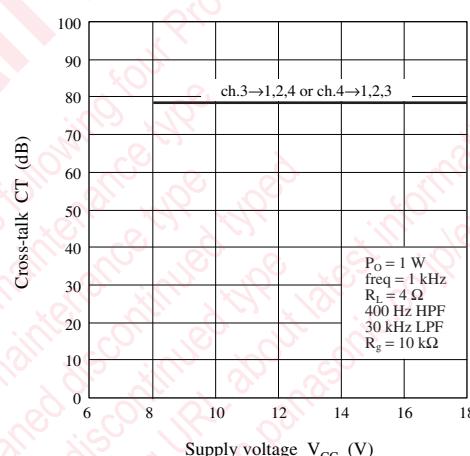
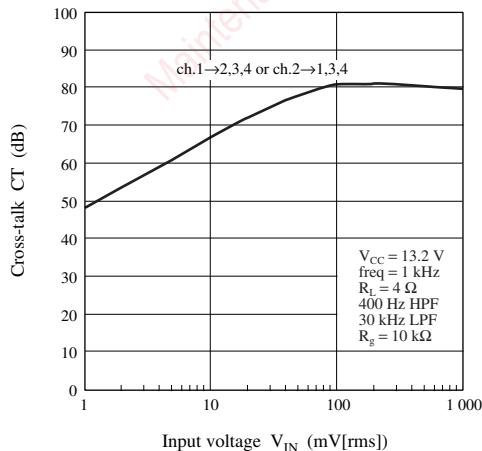
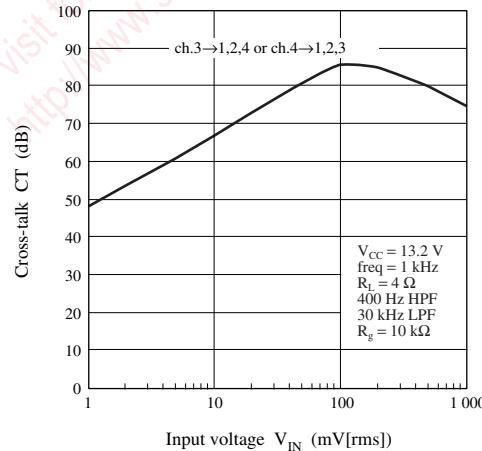


■ Technical Information (continued)

2. Main characteristics (continued)

MT — V_{IN}

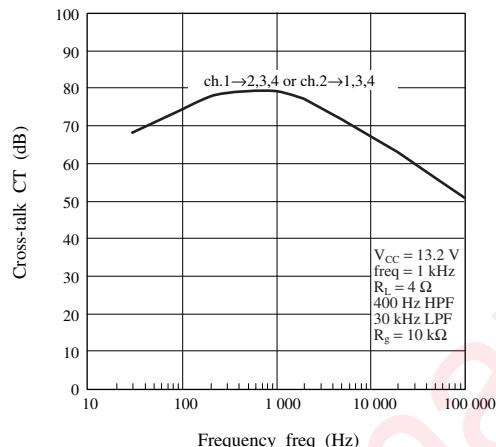
MT — freq

CT — V_{CC}CT — V_{CC}CT — V_{IN}CT — V_{IN}

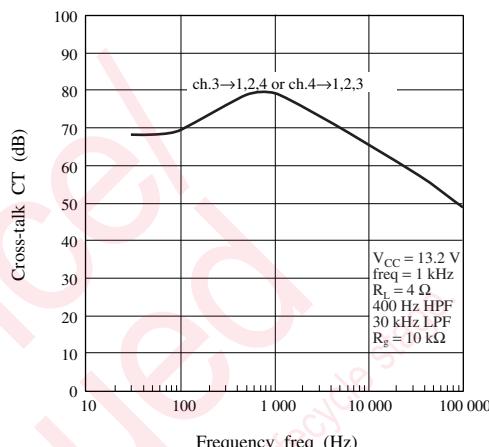
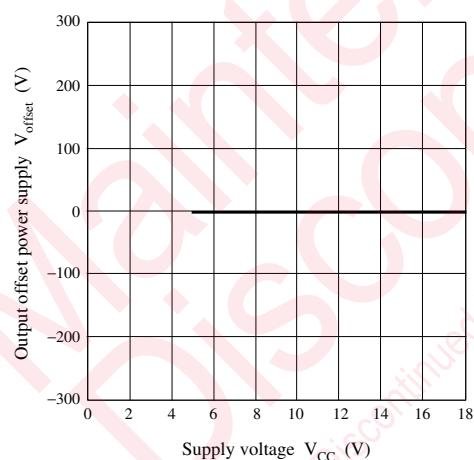
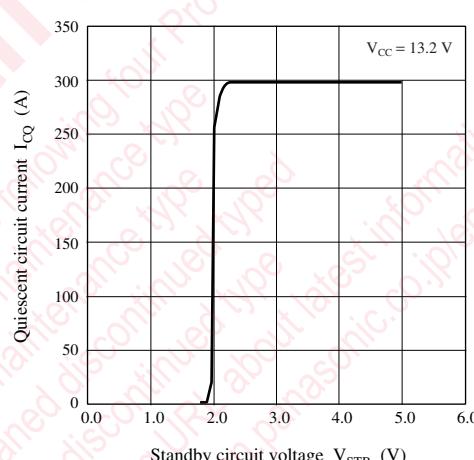
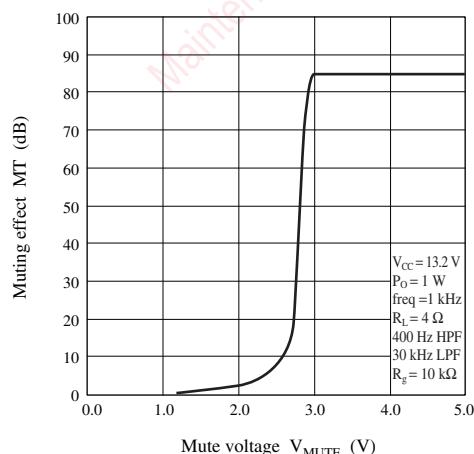
■ Technical Information (continued)

2. Main characteristics (continued)

CT— freq

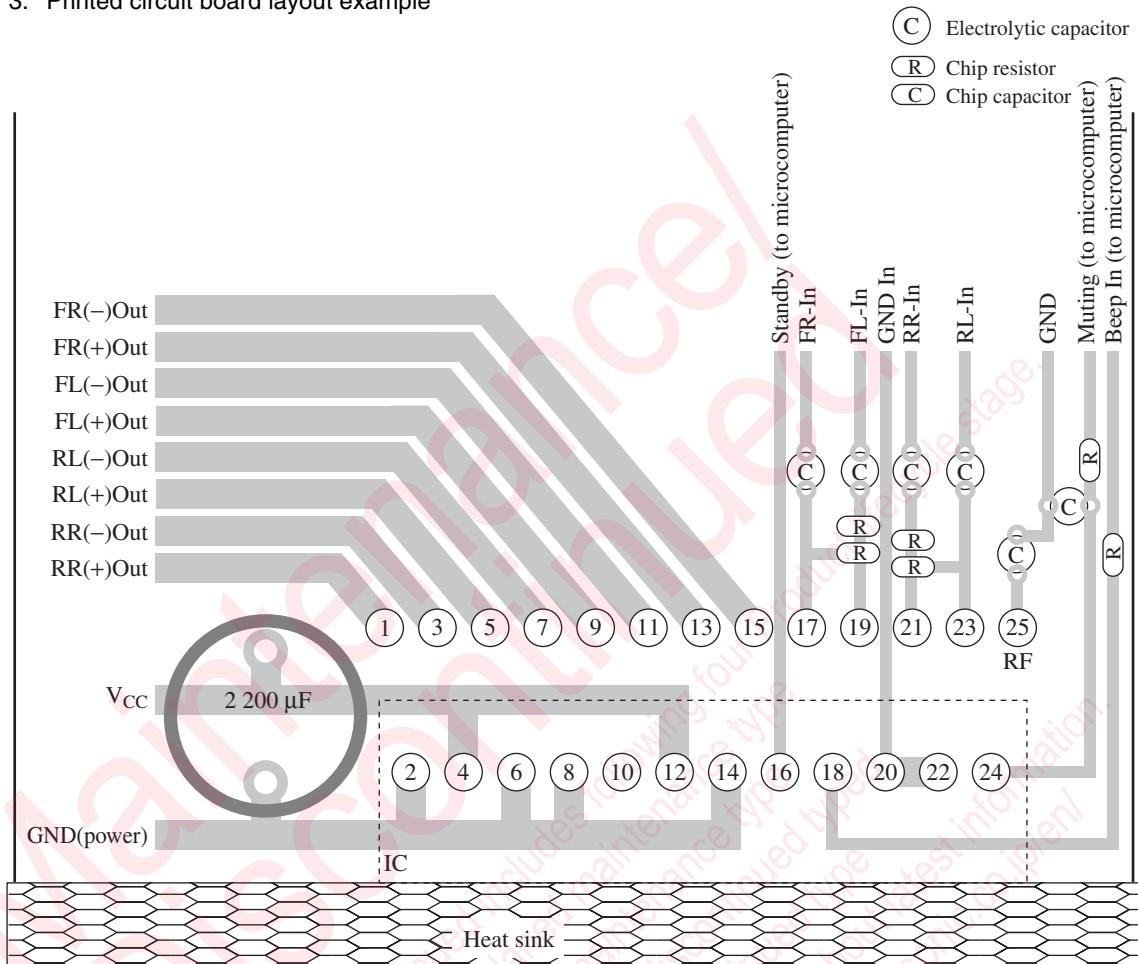


CT— freq

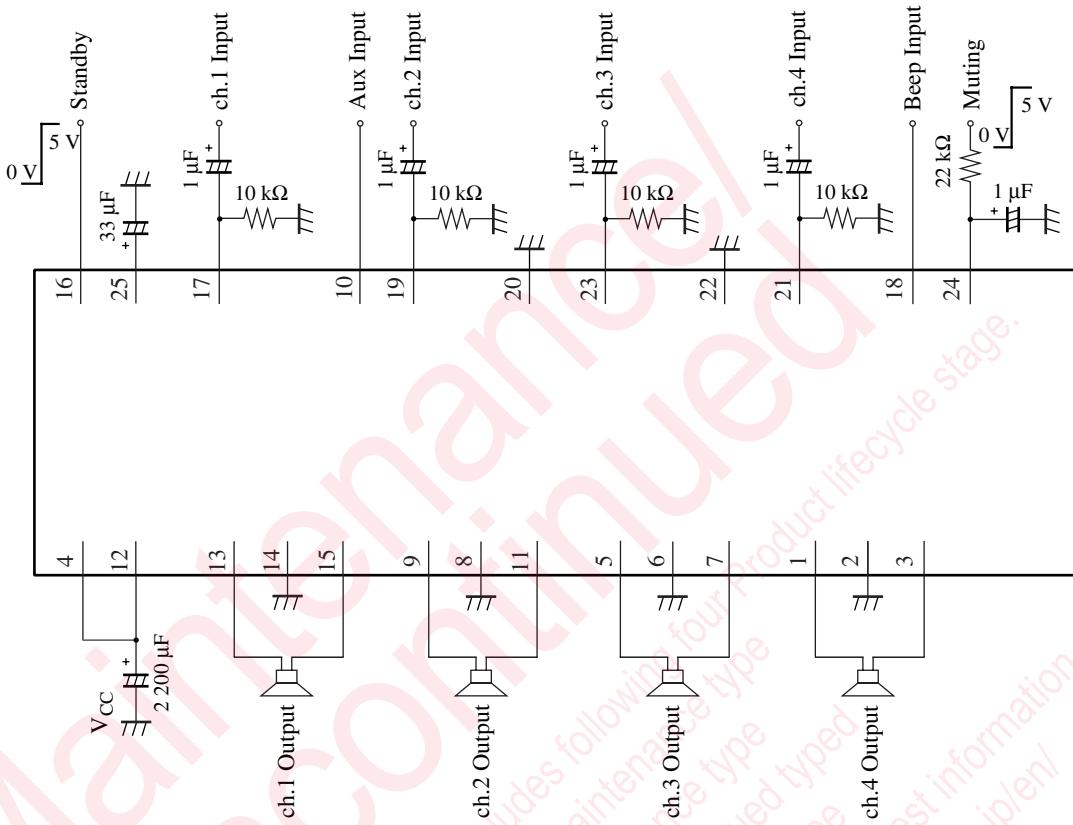
 $V_{OFFSET} — V_{CC}$  $I_{CQ} — V_{STB}$ MT — V_{MUTE} 

■ Technical Information (continued)

3. Printed circuit board layout example

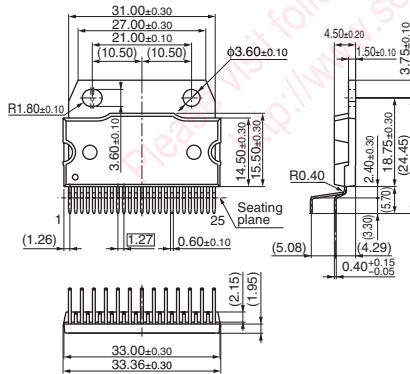


■ Application Circuit Example



■ New Package Dimensions (Unit: mm)

- HZIP025-P-0980B (Lead-free package)



Request for your special attention and precautions in using the technical information and semiconductors described in this book

- (1) If any of the products or technical information described in this book is to be exported or provided to non-residents, the laws and regulations of the exporting country, especially, those with regard to security export control, must be observed.
- (2) The technical information described in this book is intended only to show the main characteristics and application circuit examples of the products, and no license is granted under any intellectual property right or other right owned by our company or any other company. Therefore, no responsibility is assumed by our company as to the infringement upon any such right owned by any other company which may arise as a result of the use of technical information described in this book.
- (3) The products described in this book are intended to be used for standard applications or general electronic equipment (such as office equipment, communications equipment, measuring instruments and household appliances). Consult our sales staff in advance for information on the following applications:
- Special applications (such as for airplanes, aerospace, automobiles, traffic control equipment, combustion equipment, life support systems and safety devices) in which exceptional quality and reliability are required, or if the failure or malfunction of the products may directly jeopardize life or harm the human body.
 - Any applications other than the standard applications intended.
- (4) The products and product specifications described in this book are subject to change without notice for modification and/or improvement. At the final stage of your design, purchasing, or use of the products, therefore, ask for the most up-to-date Product Standards in advance to make sure that the latest specifications satisfy your requirements.
- (5) When designing your equipment, comply with the range of absolute maximum rating and the guaranteed operating conditions (operating power supply voltage and operating environment etc.). Especially, please be careful not to exceed the range of absolute maximum rating on the transient state, such as power-on, power-off and mode-switching. Otherwise, we will not be liable for any defect which may arise later in your equipment.
- Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.
- (6) Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
- (7) This book may be not reprinted or reproduced whether wholly or partially, without the prior written permission of Matsushita Electric Industrial Co., Ltd.